

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
120V	5.2mΩ@10V	105A
	7.6mΩ@10V	



合肥矽普半导体

Siliup Semiconductor Technology Co., Ltd

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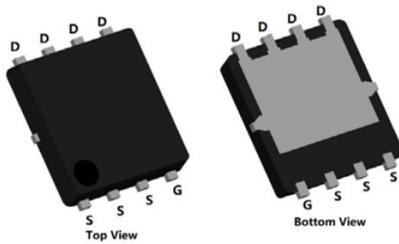
### Feature

- Fast Switching
- Low Gate Charge and R<sub>ds(on)</sub>
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

### Applications

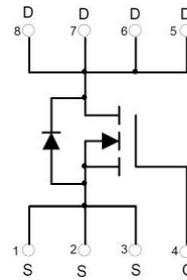
- Power switching application
- PWM Application
- DC-DC Converter

### Package



PDFN5X6-8L

### Circuit diagram



### Marking



SP012N05GNK :Device Code  
\*\* :Week Code

### Order Information

Device	Package	Unit/Tape
SP012N05GNK	PDFN5X6-8L	5000

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	120	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current (Tc=25°C)	$I_D$	105	A
Continuous Drain Current (Tc=100°C)	$I_D$	70	A
Pulse Drain Current Tested	$I_{DM}$	420	A
Single pulsed avalanche energy <sup>1</sup>	$E_{AS}$	180	mJ
Power Dissipation (Tc=25°C)	$P_D$	125	W
Power Dissipation (Tc=100°C)	$P_D$	50	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	1.0	°C/W
Storage Temperature Range	$T_{STG}$	-55 to 150	°C
Operating Junction Temperature Range	$T_J$	-55 to 150	°C

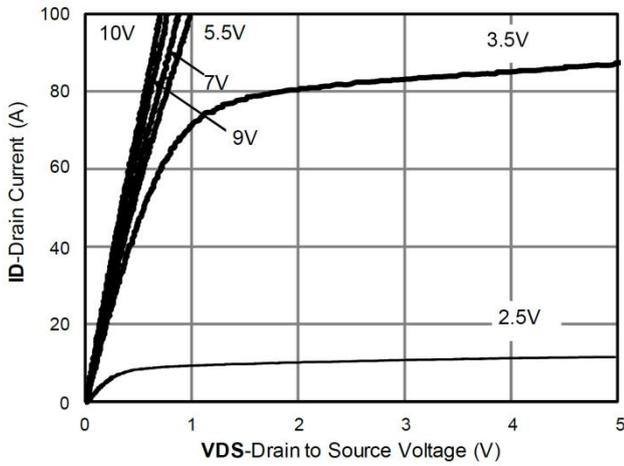
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	120	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=96V, V_{GS}=0V, T_J=25^\circ C$	-	-	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.6	2.0	2.6	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=30A$	-	5.2	7.5	m $\Omega$
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=20A$	-	7.6	-	m $\Omega$
Gate Resistance	$R_G$	$V_{DS}=60V, V_{GS}=0V, f=1MHz$	-	1.1	-	$\Omega$
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=60V, V_{GS}=0V, f=1MHz$	-	3478	-	pF
Output Capacitance	$C_{oss}$		-	1852	-	
Reverse Transfer Capacitance	$C_{rss}$		-	60	-	
Total Gate Charge	$Q_g$	$V_{DS}=60V, V_{GS}=10V, I_D=40A$	-	42	-	nC
Gate-Source Charge	$Q_{gs}$		-	9	-	
Gate-Drain Charge	$Q_{gd}$		-	10	-	
Gate Plateau Voltage	$V_{plateau}$		-	3.8	-	V
<b>Switching Characteristics</b>						
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=60V, V_{GS}=10V, R_G=2.7\Omega, I_D=40A$	-	18	-	nS
Rise Time	$T_r$		-	28	-	
Turn-Off Delay Time	$T_{d(off)}$		-	38	-	
Fall Time	$T_f$		-	32	-	
<b>Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A, T_J=25^\circ C$	-	-	1.2	V
Diode Continuous Current	$I_S$	$I_S=40A, di/dt=100A/\mu s, T_J=25^\circ C$	-	-	105	A
Reverse recover time	$T_{rr}$		-	65	-	nS
Reverse recovery charge	$Q_{rr}$		-	72	-	nC

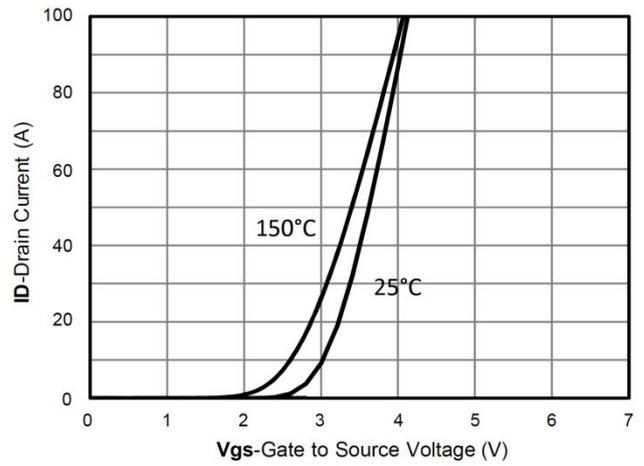
**Note:**

- The EAS test condition is  $V_{DD}=60V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$

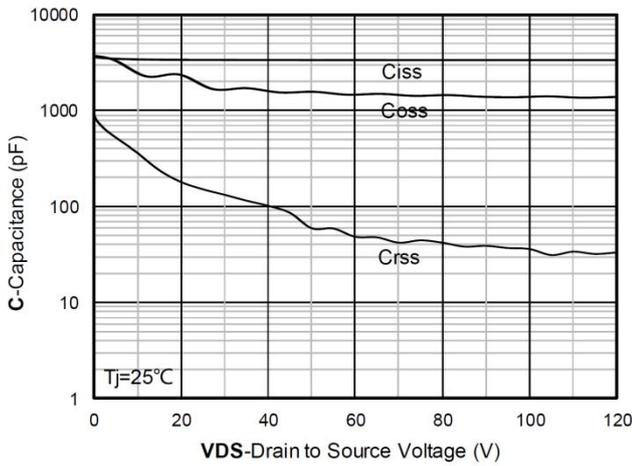
**Typical Characteristics**



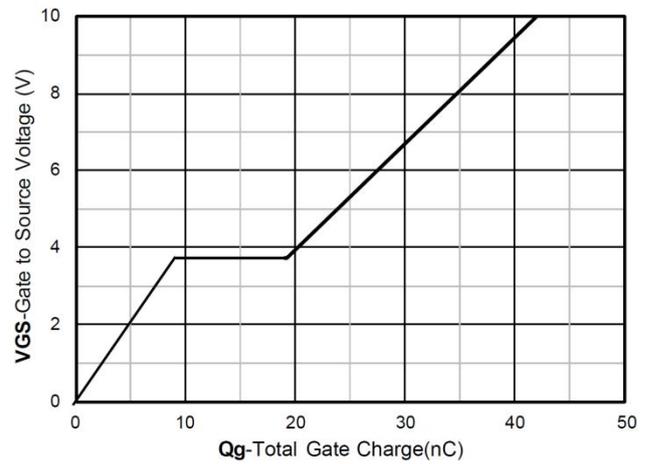
Output Characteristics



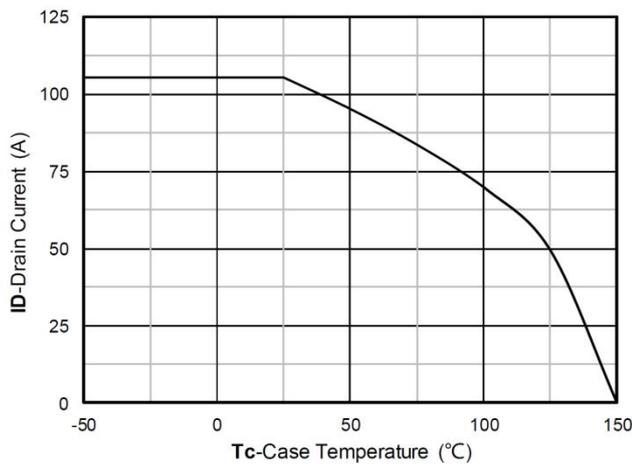
Transfer Characteristics



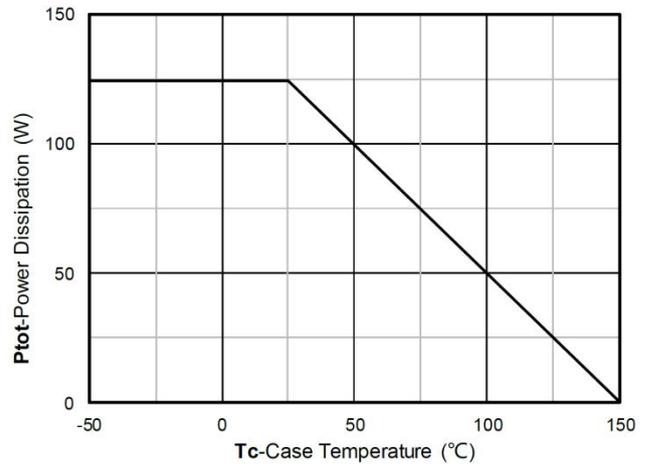
Capacitance Characteristics



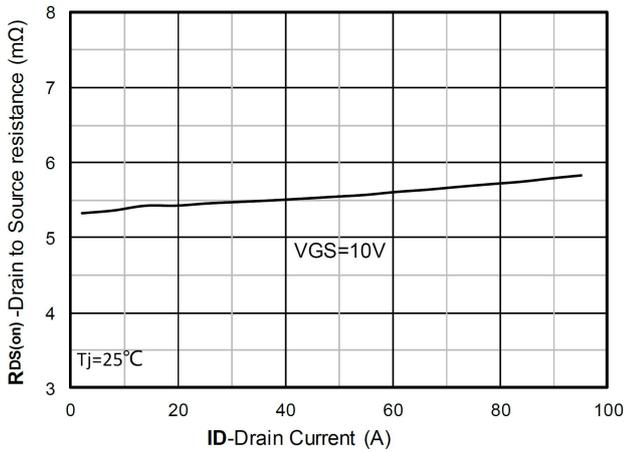
Gate Charge



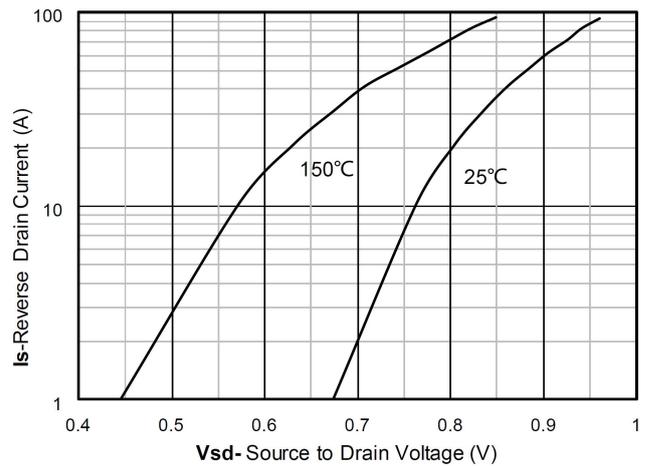
Current dissipation



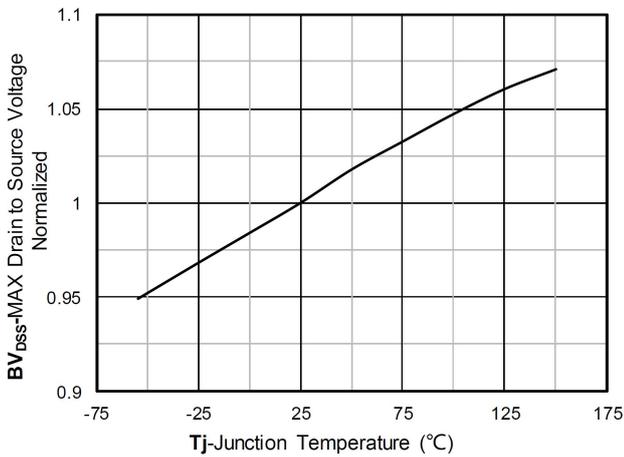
Power dissipation



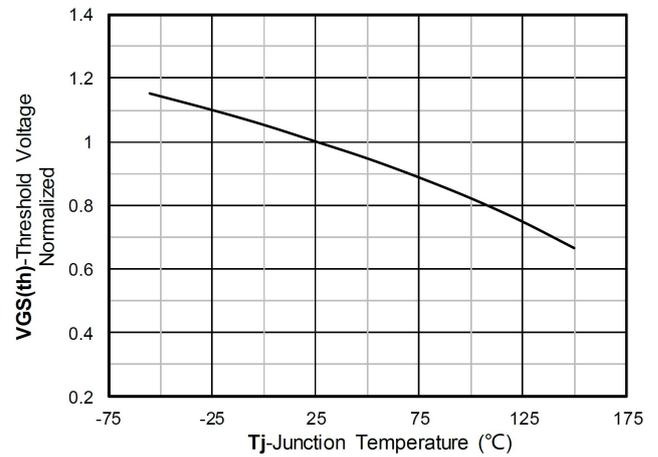
R<sub>DS(on)</sub> VS Drain Current



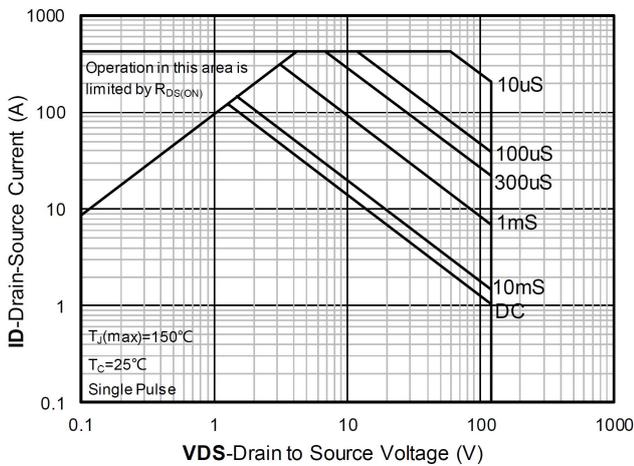
Forward characteristics of reverse diode



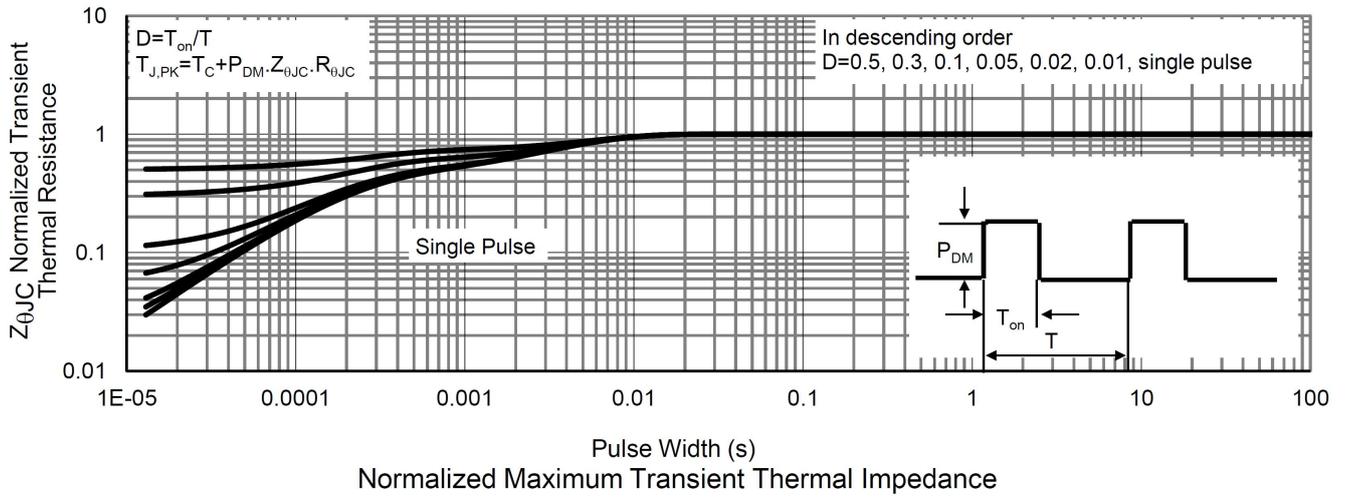
Normalized breakdown voltage



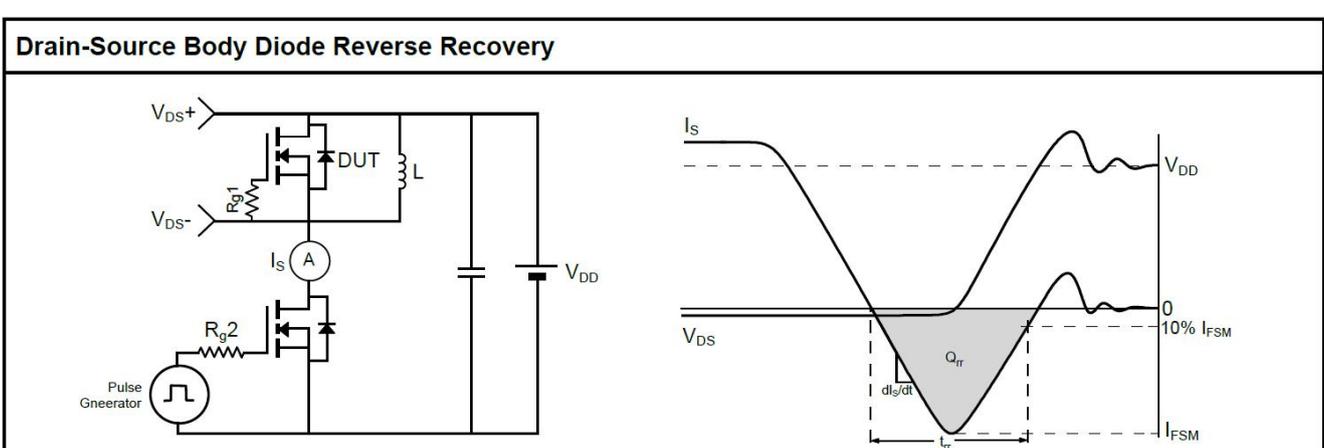
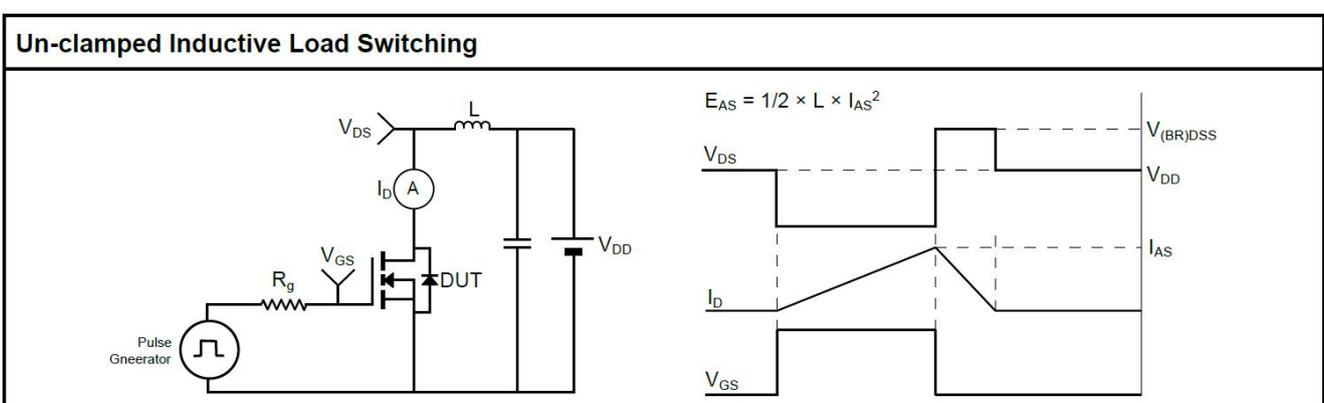
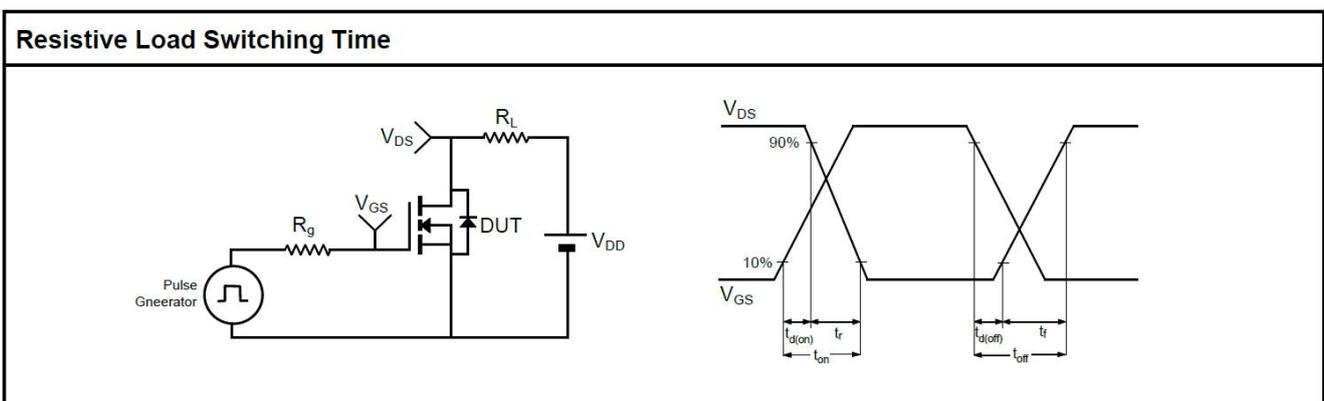
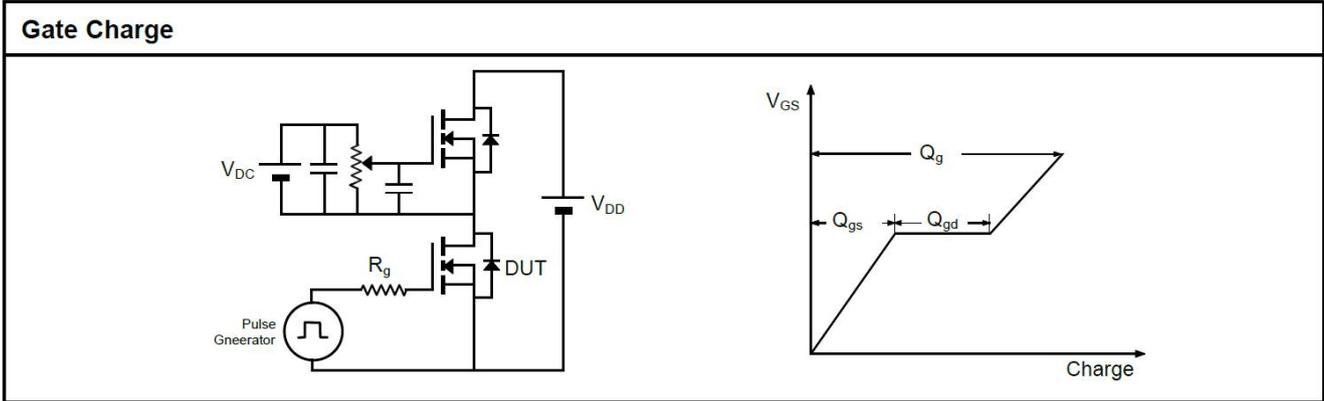
Normalized Threshold voltage



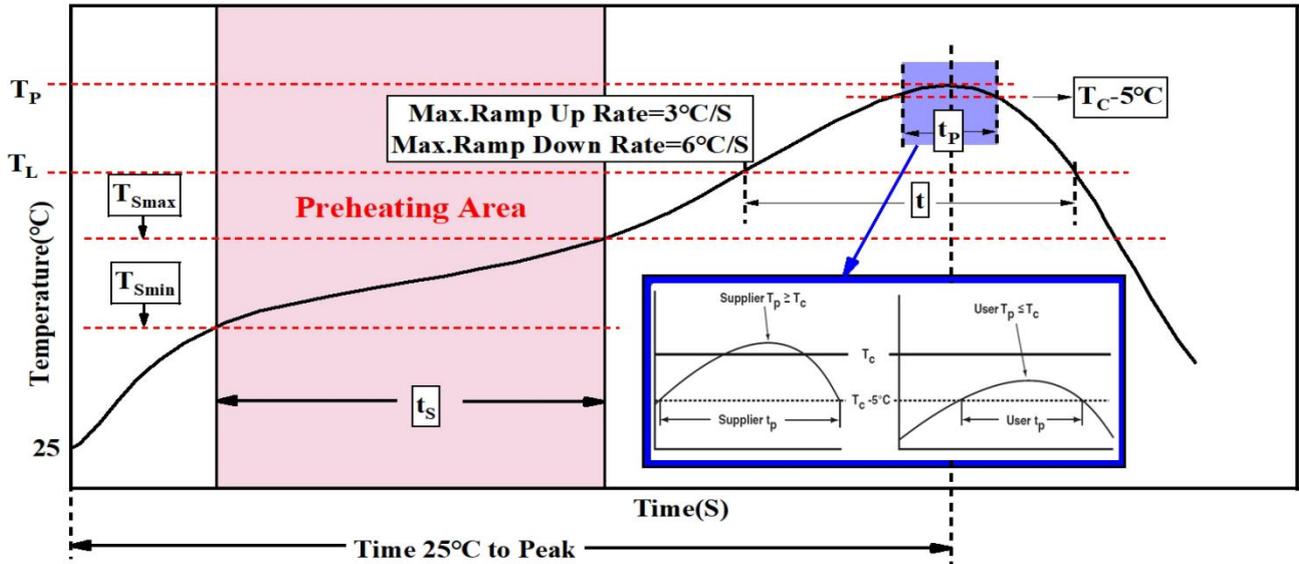
Safe Operation Area



**Test Circuit**



**Temperature Profile for IR Reflow Soldering**



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min (T <sub>Smin</sub> )	100°C	150°C
Temperature max (T <sub>Smax</sub> )	150°C	200°C
Time (T <sub>Smin</sub> to T <sub>Smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Average ramp-up rate (T <sub>Smax</sub> to T <sub>p</sub> )	3 °C/second max.	3°C/second max.
Liquidous temperature (T <sub>L</sub> )	183 °C	217°C
Time at liquidous (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak package body Temperature e (T <sub>p</sub> )*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t <sub>p</sub> )** within 5°C of the specified classification temperature (T <sub>c</sub> )	20** seconds	30** seconds
Average ramp-down rate (T <sub>p</sub> to T <sub>Smax</sub> )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T <sub>p</sub> ) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t <sub>p</sub> ) is defined as a supplier minimum and a user maximum		

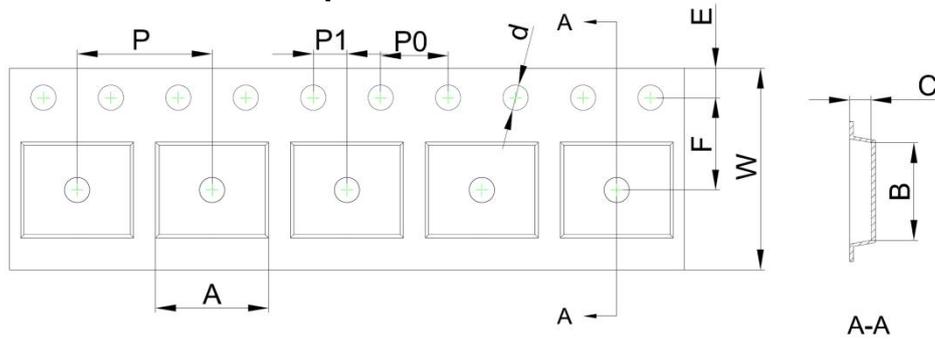
Table 1. SnPb Eutectic Process – Classification Temperatures (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T<sub>c</sub>)

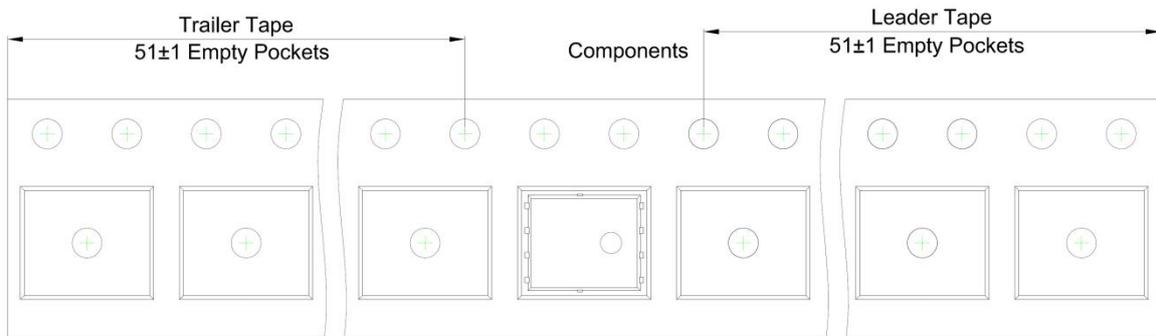
Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

**PDFN5X6-8L Embossed Carrier Tape**

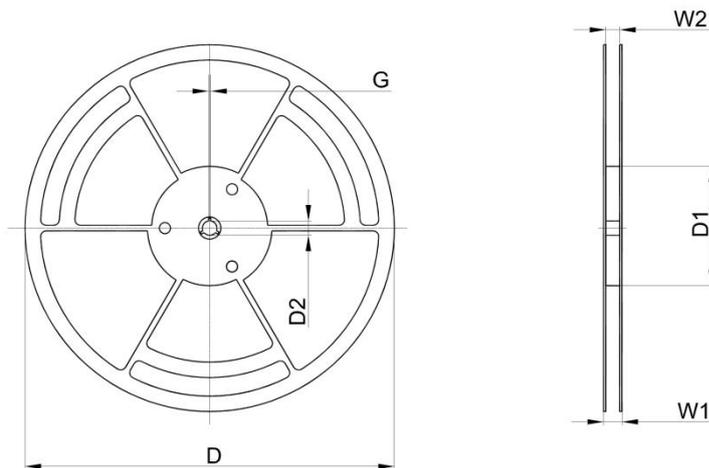


Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFN5X6-8L	6.30	5.30	1.10	Φ1.50	1.75	5.50	4.00	8.00	2.00	12.00

**PDFN5X6-8L Tape Leader and Trailer**



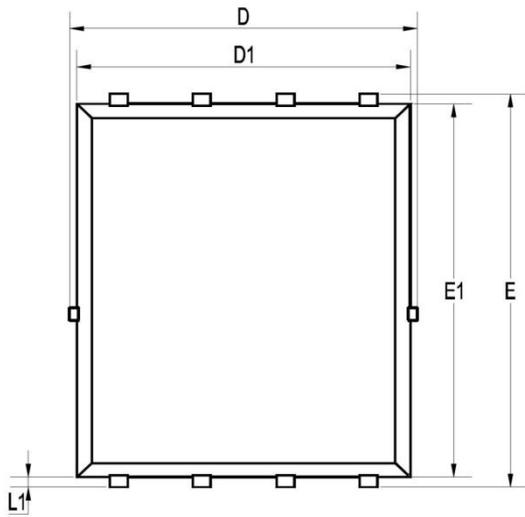
**PDFN5X6-8L Reel**



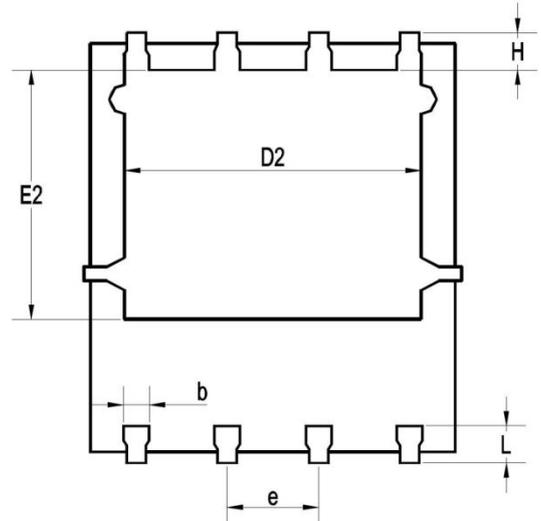
Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13" Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365

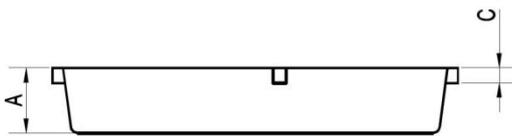
**PDFN5X6-8L Package Information**



Top View  
[顶视图]



Bottom View  
[背视图]



Side View  
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.120	0.035	0.044
b	0.330	0.510	0.013	0.020
C	0.110	0.340	0.004	0.013
D	4.700	5.260	0.185	0.207
D1	4.700	5.100	0.185	0.201
D2	3.560	4.500	0.140	0.177
E	5.750	6.250	0.226	0.246
E1	5.600	6.000	0.220	0.236
E2	3.180	3.660	0.125	0.144
e	1.170	1.370	0.046	0.054
L	0.350	0.710	0.014	0.028
L1	0.060	0.200	0.002	0.008
H	0.350	0.710	0.014	0.028